

**Notice of References Cited**

Application/Control No.

09/777,435

Applicant(s)/Patent Under  
Reexamination  
SINGH ET AL.

Examiner

Elias Desta

Art Unit

2857

Page 1 of 1

**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,279,108	08-2001	Squires et al.	712/244
	B	US-4,979,055	12-1990	Squires et al.	360/69
	C	US-6,332,110	12-2001	Wolfe, Thomas D.	702/22
	D	US-6,052,653	04-2000	Mazur et al.	702/57
	E	US-6,513,151	01-2003	Erhardt et al.	716/21
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

**FOREIGN PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Pierce, 'Golden Nuggets of AMHS Modeling and Design for Semiconductor Wafer Fabrication', January 1994, IEEE, pages 200-204
	V	SANDIA NATIONAL LABORATORIES, 'BMP, Best Manufacturing Practices', May 1995, College Park Maryland, pages 1-58
	W	
	X	

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.